



General Description

The AOZ8231A is a one-line bi-directional transient voltage suppressor diode designed to protect voltage sensitive electronics from high transient conditions and ESD.

This device incorporates one TVS diode in an ultra-small DFN 1006 package. It may be used to meet the ESD immunity requirements of EC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge).

The AOZ8231A comes in a RoHS compliant, Halogen-Free DFN 1.0 mm x 0.6 mm package and is rated over a -40 °C to +85 °C ambient temperature range.

The ultra-small 1.0 mm x 0.6 mm x 0.5 mm DFN package makes it ideal for applications where PCB space is a premium. The small size and high ESD protection makes it ideal for protecting voltage sensitive electronics from high transient conditions and ESD.

Applications

- Portable handheld devices
- Keypads, data lines, buttons
- Notebook computers
- Digital Cameras
- Portable GPS
- MP3 players

Features

- ESD protection for high-speed data lines
 - AOZ8231ADI-02:
 - Exceeds: IEC 61000-4-2 (ESD) ± 30 kV (air), ± 30 kV (contact)
 - Human Body Model (HBM) ± 30 kV
 - IEC 61000-4-5 (Lightning) 6 A (8/20 μS)
 - IEC 61000-4-4 (EFT) 40 A

AOZ8231ADI-03:

- Exceeds: IEC 61000-4-2 (ESD) ± 30 kV (air), ± 30 kV (contact)
- Human Body Model (HBM) ± 30 kV
- IEC 61000-4-5 (Lightning) 6 A (8/20 μS)
- IEC 61000-4-4 (EFT) 40 A

AOZ8231ADI-05:

- Exceeds: IEC 61000-4-2 (ESD) ± 30 kV (air), ±30 kV (contact)
- Human Body Model (HBM) ± 30 kV
- IEC 61000-4-5 (Lightning) 5 A (8/20 μS)
- IEC 61000-4-4 (EFT) 40 A

AOZ8231ADI-08:

- Exceeds: IEC 61000-4-2 (ESD) ± 30 kV (air), ± 30 kV (contact)
- Human Body Model (HBM) ± 30 kV
- IEC 61000-4-5 (Lightning) 5 A (8/20 μS)
- IEC 61000-4-4 (EFT) 40 A

AOZ8231ADI-12:

- Exceeds: IEC 61000-4-2 (ESD) ± 30 kV (air), ± 30 kV (contact)
- Human Body Model (HBM) ± 30 kV
- IEC 61000-4-5 (Lightning) 4 A (8/20 μS)

– IEC 61000-4-4 (EFT) 40 A

- AOZ8231ADI-24:
- Exceeds: IEC 61000-4-2 (ESD) ± 18 kV (air), ± 15 kV (contact)
- Human Body Model (HBM) ± 15 kV
- IEC 61000-4-5 (Lightning) 2.5 A (8/20 μS)
- IEC 61000-4-4 (EFT) 40 A
- Small package saves board space
- Low insertion loss
- Low clamping voltage
- Low operating voltage
- Pb-free device





Typical Application

Pin Configuration





Bidirection Protection of Single Line

Ordering Information

Part Number	Ambient Temperature Range	Package	Environmental		
AOZ8231ADI-02					
AOZ8231ADI-03					
AOZ8231ADI-05	-40 °C to +85 °C	DFN 1.0 x 0.6	Green Product		
AOZ8231ADI-08	-40 C 10 +85 C		Green Floddet		
AOZ8231ADI-12					
AOZ8231ADI-24					



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant.

Please visit www.aosmd.com/media/AOSGreenPolicy.pdf for additional information.

Absolute Maximum Ratings

Exceeding the Absolute Maximum ratings may damage the device.

	Rating for AOZ8231ADI						
Parameter	-02	-03	-05	-08	-12	-24	
VP – VN	2.5 V	3.3 V	5 V	8 V	12 V	24 V	
Peak Pulse Current, t _P = 8/20 μs	6 A	6 A	5 A	5 A	4 A	2.5 A	
Storage Temperature (T _S)			-65 °C to	+150 °C			
ESD Rating per IEC61000-4-2, Contact ⁽¹⁾	± 30 kV	± 30 kV	± 30 kV	± 30 kV	± 30 kV	± 15 kV	
ESD Rating per IEC61000-4-2, Air ⁽¹⁾	± 30 kV	± 30 kV	± 30 kV	± 30 kV	± 30 kV	±18 kV	
ESD Rating per Human Body Model ⁽²⁾	± 30 kV	± 30 kV	± 30 kV	± 30 kV	± 30 kV	± 15 kV	

Notes:

1. IEC 61000-4-2 discharge with C_{Discharge} = 150 pF, R_Discharge = 330 $\Omega.$

2. Human Body Discharge per MIL-STD-883, Method 3015 C_{Discharge} = 100 pF, R_{Discharge} = 1.5 kΩ.

Maximum Operating Ratings

Parameter	Rating			
Junction Temperature (T _J)	-40 °C to +125 °C			

Electrical Characteristics

 $T_A = 25$ °C unless otherwise specified.

Parameter
Reverse Peak Pulse Current, (t_{period} = 100 ns, t_r = 1 ns)
Clamping Voltage @ I _{PP}
Working Peak Reverse Voltage
Maximum Reverse Leakage Current
Breakdown Voltage
Capacitance @ V_R = 0 and f = 1 MHz



	Device	V _{RWM} (V)	V _{BR} (V) Min. @	Ι _R (μΑ)	V _{CL} Max. ⁽³⁾				C _J (pF) ⁽³⁾		
Device	Marking	Max.	1mA	Max.	I _{PP} = 1 A	I _{PP} = 5 A	I _{PP} = 12 A	Min.	Тур.	Max.	
AOZ8231ADI-02	Р	2.5	3.0	0.1	6.5	9.0	12.5	4.4	5.5	7.0	
AOZ8231ADI-03	D	3.3	3.7	0.1	7.5	10.0	13.5	4.4	5.5	7.0	
AOZ8231ADI-05	E	5.0	5.5	0.1	10.5	13.5	15.5	10.4	13.0	14.0	
AOZ8231ADI-08	Y	8.0	9.5	0.1	15.0	18.0	22.5	19.0	23.0	27.0	
AOZ8231ADI-12	F	12.0	13.0	0.1	20.0	23.0	26.0	10.4	13.0	14.0	
AOZ8231ADI-24	R	24.0	27.0	0.1	35.0	38.0	39.0	9.6	12.0	15.0	

Note:

3. Guaranteed by design and characterization.



Typical Performance Characteristics



Package Dimensions, DFN 1.0 x 0.6



RECOMMENDED LAND PATTERN



UNIT: mm

Dimensions in millimeters

Symbols	Min.	Nom.	Max.				
А	0.47	0.51	0.55				
A1	0.00	0.02	0.05				
b	0.45	0.50	0.55				
D	0.60 BSC						
Е	1.00 BSC						
е	0.65 BSC						
L	0.20 0.25		0.30				
aaa	0.05						
CCC	0.03						
ddd		0.10					

Dimensions in inches

Symbols	Min.	Nom.	Max.
А	0.019	0.020	0.022
A1	0.000	0.001	0.002
b	0.018	0.020	0.022
D		0.024	
Е		0.039	
е		0.026	
L	0.008	0.010	0.012
aaa		0.002	
CCC		0.001	
ddd		0.004	

Notes:

1. Dimensions and tolerancing conform to ASME Y14.5-2009.

2. All dimensions are in milliteters.

 $\underline{3}$ "e" represents the terminal grid pitch.

4. N is the total number of terminals.

A visual index feature must be located within the hatched area. Typical index feature (chamfer) must be located on the edge of the Pin#1 feature.

This dimension includes stand-off height "A1" and packaged body thickness, but does not include attached feature e.g. external heatsink or chip capacitors, an internal heatslug is not considered as attached feature.

A Dimension "A1" is primarily terminal plating, and does not include small metal protrusions.

Tape and Reel Dimensions, DFN 1.0 x 0.6



Reel







UNIT: mm

Tape Size	Reel Size	М	Ν	w	W1	Н	к	S	G	R	V
8mm	ø178	ø178 ±0.5	ø55 ±1	8.4 +1.5/-0	Max. 14.4	ø13.0 ±0.5	Max. 10.1	2.0 ±0.5	N/A	N/A	N/A

Leader / Trailer & Orientation

er / Traller & Orle	ntation
TVS Unit Per Reel: 10000pcs	
	Trailer Tape Components Tape Leader Tape 300mm Min Orientation in Pocket 500mm Min.



Part Marking



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